

## FEATURES

- highly configurable, versatile DSP platform
- high quality two-channel AGC signal processing
- fully programmable via serial data interface
- high performance data converters - dual, over-sampled A/Ds; over-sampled D/A with efficient switched-mode output power amp
- drives zero-bias 2-terminal receivers
- multiple communication rates up to 85.3kb/s
- thinSTAX™ packaging - CIC size
- multi-memory
- internal/external volume control
- volume control taper determined by external VC

## DESCRIPTION

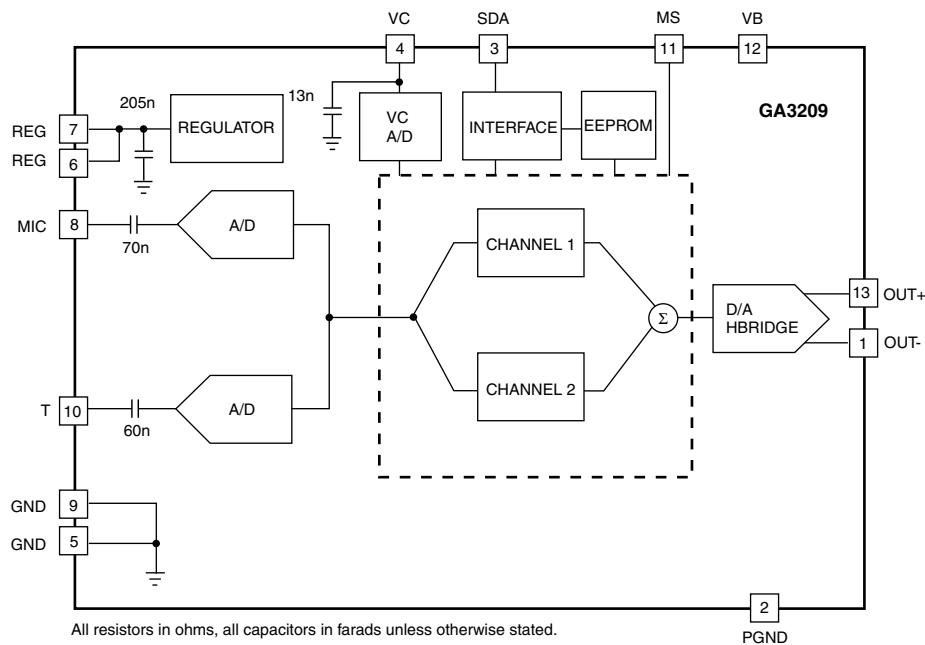
The GA3209 hybrid is a programmable DSP system based on a two-channel compression circuit. It can be used as a platform for a wide range of hearing aid applications. It's extensive programmability and compact size make it ideal for sophisticated CIC applications. The reflowable thinSTAX™ packaging enables easy use in BTE applications. This very versatile DSP hybrid is capable of multiple configurations and has a wide range of functions.

The GA3209 hybrid code programmed into the GC5050 controller chip is "4".

## thinSTAX™ PACKAGING

Hybrid typical dimensions:

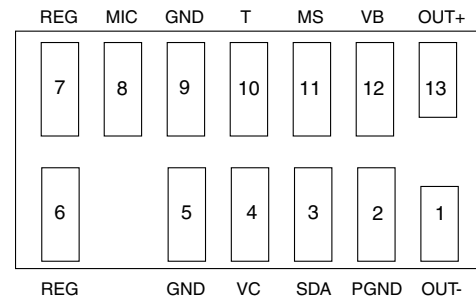
0.227 x 0.125 x 0.060 in  
(5.76 x 3.18 x 1.52 mm)



BLOCK DIAGRAM

**ABSOLUTE MAXIMUM RATING**

Operating Temperature Range	-10°C to 40°C
Storage Temperature Range	-20°C to 70°C
Absolute Maximum Power Dissipation	25mW
Maximum Operating Supply Voltage	1.5VDC
Absolute Maximum Supply Voltage	2VDC

**PAD CONNECTION****ELECTRICAL CHARACTERISTICS**Conditions: Supply Voltage  $V_B = 1.3V$ ; Temperature = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Hybrid Current	$I_{AMP}$	See current consumption section	-	700	-	$\mu A$
Minimum Operating Supply Voltage	$V_{BOFF}$	Ramp down	0.94	1.0	1.05	V
Supply Voltage turn on threshold	$V_{BON}$	Ramp up	1.06	1.10	1.16	V
Supply Voltage Hysteresis			90	100	110	mV
Supply Voltage during Communication	$V_{BC}$	During Communication	1.19	1.35	1.5	V
Hybrid Current during Communication	$I_P$	Programming (<5 ms)	-	3.7	-	mA
EEPROM Burn Cycles		Note 2	100k	-	-	cycles
Low Frequency System Bandwidth			-	125	-	Hz
High Frequency System Bandwidth			-	16	-	kHz
Total Maximum System Gain	$A_V$	$V_{IN} = -95$ dBV @ 3kHz; squelch disabled See Note 1.	-	83	-	dB
Converter Gain	$A_{CONV}$	A/D + D/A gain.	-	29	-	dB
Total Harmonic Distortion	THD	$V_{IN} = -40$ dBV	-	-	1	%
THD at Maximum Input	THD <sub>M</sub>	$V_{IN} = -15$ dBV, HRX - ON	-	-	3	%
Clock Frequency	$f_{clk}$		1.945	2.048	2.151	MHz
<b>REGULATOR</b>						
Regulator Voltage	$V_{REG}$		0.90	0.95	1.00	V
Regulator Supply Rejection	PSRR <sub>REG</sub>		-	50	-	dB
<b>INPUT</b>						
Input Referred Noise	IRN	Bandwidth 100Hz - 8kHz	-	-	-106	dBV
Input Impedance	$Z_{IN}$		-	16	-	k $\Omega$
Anti-alias Filter Rejection (input referred)		$f = f_{clk} - 8kHz$ , $V_{IN} = -40dBV$	-	80	-	dB
Maximum Input Level			-	-15	-	dBV
Input Dynamic Range		HRX - ON, Bandwidth 100Hz - 8kHz	-	95	-	dB
Audio Sample Rate			-	32	-	kHz
A/D Dynamic Range		Bandwidth 100Hz - 8kHz	-	86	-	dB
Mic - Telecoil Isolation		Identical Front and Rear channel configuration	-	30	-	dB

**ELECTRICAL CHARACTERISTICS (Continued)**

Conditions: Supply Voltage  $V_B = 1.3V$ ; Temperature = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>OUTPUT</b>						
Maximum RMS Output Voltage		0dBFS $f = 1kHz$	-	-1	-	dBV
D/A Dynamic Range		Bandwidth 100Hz - 8kHz	-	80	-	dB
Output Impedance	$Z_{OUT}$	Note 2	-	-	20	$\Omega$
<b>VOLUME CONTROL</b>						
Volume Control Resistance	$R_{VC}$		-	200	-	k $\Omega$
Volume Control Range	$\Delta A$		47.5	48.13	48.5	dB
<b>MS INPUT</b>						
Pull Down Resistance			-	1	-	M $\Omega$
Logic 1 Voltage			$V_{REG}$	-	$V_B$	V
<b>SDA INPUT</b>						
Logic 0 Voltage		Note 2	0	-	0.3	V
Logic 1 Voltage		Note 2	1	-	1.3	V
<b>SDA OUTPUT</b>						
Standby Pull Up Current			1.4	2	2.6	$\mu A$
Sync Pull Up Current			450	500	550	$\mu A$
Logic 0 Current (Pull Down)			225	250	275	$\mu A$
Logic 1 Current (Pull Up)			225	250	275	$\mu A$
Synchronization Time (Synchronization Pulse Width)	$T_{SYNC}$	Baud = 0 Baud = 1 Baud = 2	237 118 59	250 125 62.5	263 132 66	$\mu s$

NOTE 1: Total System Gain consists of: Wideband System Gain + High and Low Independent Channel Gains + Converter Gain  
Total System Gain is calibrated during Cal/Config process.

NOTE 2: Sample tested.

**SUPPORT SOFTWARE**

All support software for the GA3209 is available from Gennum  
Web Site [www.gennum.com/hip/software/paragon\\_sw.html](http://www.gennum.com/hip/software/paragon_sw.html)

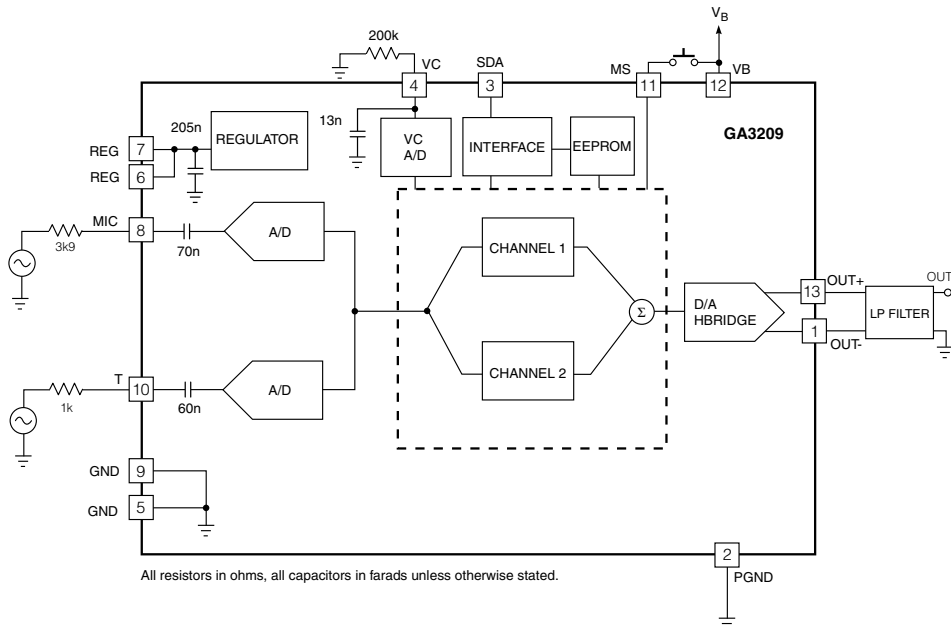


Fig. 1 Test Circuit

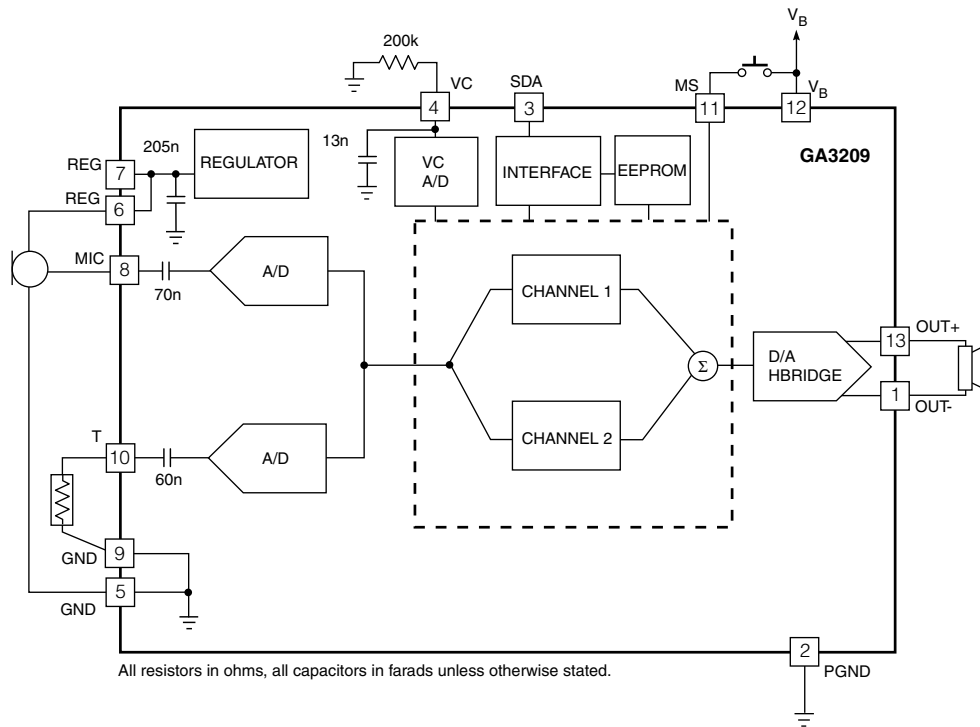


Fig. 2 Typical Application Circuit

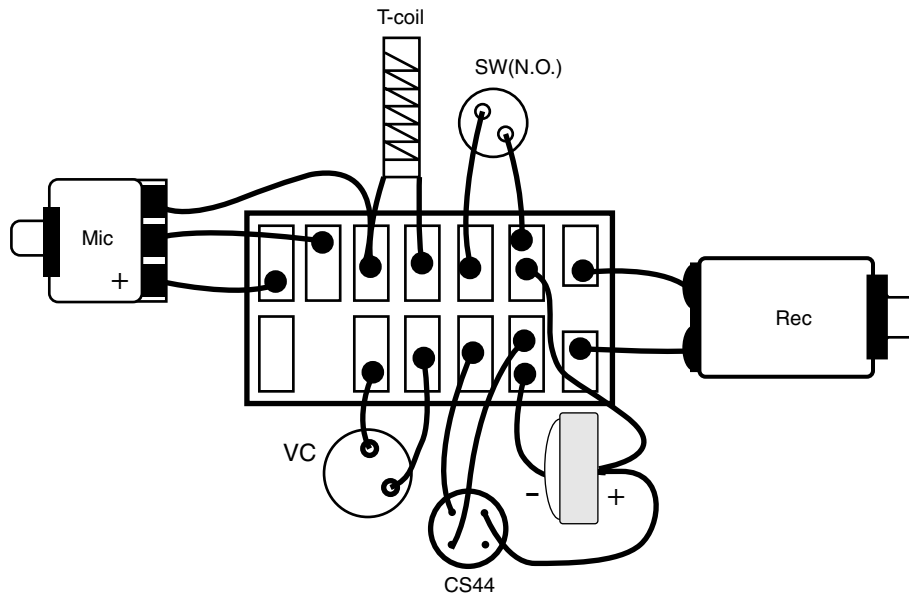
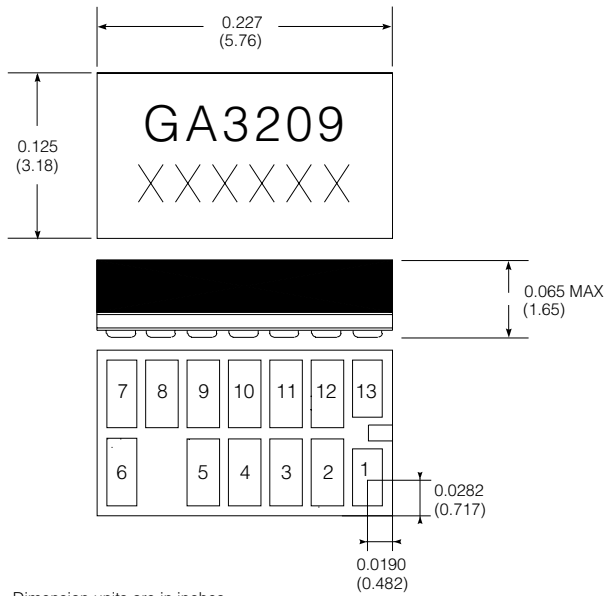


Fig. 3 Assembly Diagram

**PACKAGE DIMENSIONS**



Dimension units are in inches.  
 Dimensions in parentheses are in millimetres, converted from inches and include minor rounding errors.  
 1.0000 inches = 25.400mm  
 Dimension tolerances: ±0.003 (±0.08) unless otherwise stated.  
 Work order number: XXXXXX  
 Minimum Pad Size: 0.022 x 0.042 (0.56 x 1.05)  
 This Hybrid is designed for either point-to-point manual soldering or for reflow according to Gennum's reflow process (Information Note 521-45).

**PAD LOCATION**

PAD NO.	PAD POSITION		PAD DIMENSION	
	X	Y	Xdim	Ydim
1	0	0	22.2	41.5
2	-31.1	3	23.6	47.5
3	-62.9	3	23.6	47.5
4	-94.7	3	23.6	47.5
5	-126.5	3	23.6	47.5
6	-189.45	3	22.3	47.5
7	-189.45	65.5	22.3	47.5
8	-158.35	65.5	23.5	47.5
9	-126.5	65.5	23.6	47.5
10	-94.7	65.5	23.6	47.5
11	-62.9	65.5	23.6	47.5
12	-31.1	65.5	23.6	47.5
13	0	68.5	22.2	41.5
1	0	0	0.564	1.054
2	-0.790	0.076	0.599	1.207
3	-1.598	0.076	0.599	1.207
4	-2.405	0.076	0.599	1.207
5	-3.213	0.076	0.599	1.207
6	-4.812	0.076	0.566	1.207
7	-4.812	1.664	0.566	1.207
8	-4.022	1.664	0.597	1.207
9	-3.213	1.664	0.599	1.207
10	-2.405	1.664	0.599	1.207
11	-1.598	1.664	0.599	1.207
12	-0.790	1.664	0.599	1.207
13	0	1.740	0.564	1.054

GA3209

<p><b>CAUTION</b>                  ELECTROSTATIC SENSITIVE DEVICES                  DO NOT OPEN PACKAGES OR HANDLE EXCEPT AT A STATIC-FREE WORKSTATION</p>
<p><b>DOCUMENT IDENTIFICATION</b>                  PRELIMINARY DATA SHEET                  The product is in a preproduction phase and specifications are subject to change without notice.</p>

<p><b>REVISION NOTES:</b>                  Correction to Package Dimensions diagram.                   For latest product information, visit <a href="http://www.gennum.com">www.gennum.com</a></p>
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